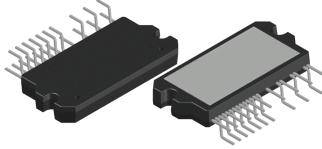
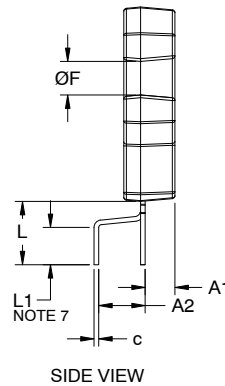
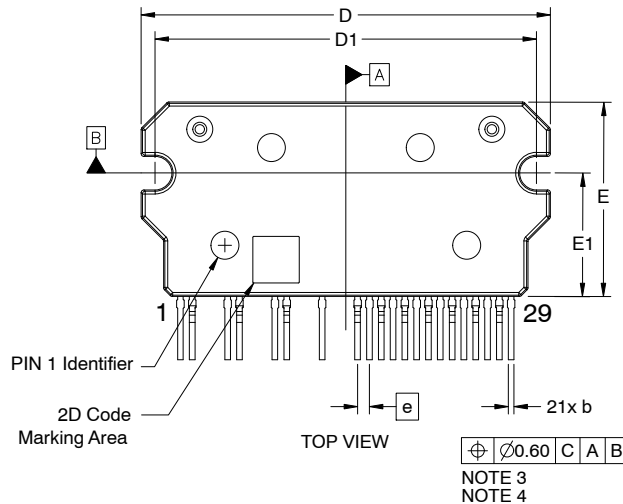


SIP29 44.00x20.90x5.50, 1.27P
CASE 127FG
ISSUE A

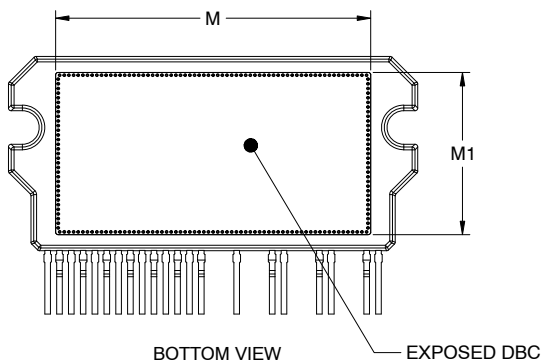
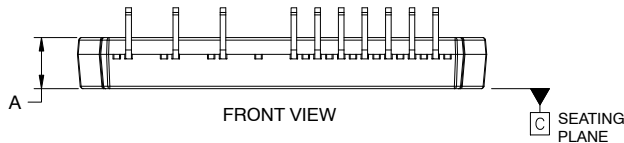
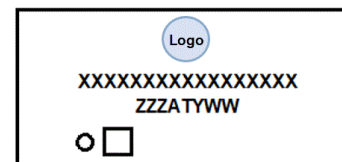
DATE 04 SEP 2024


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b and c APPLY TO THE PLATED LEADS AND ARE MEASURED BETWEEN 1.00 AND 2.00 FROM THE LEAD TIP.
4. POSITION OF THE LEAD IS DETERMINED AT THE ROOT OF THE LEAD WHERE IT EXITS THE PACKAGE BODY.
5. PIN 1 IDENTIFICATION IS A MIRRORED SURFACE INDENT.
6. MISSING PINS ARE 3,4,7,8,11,12,14 AND 15.
7. L1 IS THE STRAIGHT PORTION OF THE LEAD AFTER THE BEND.



DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	5.30	5.50	5.70
A1	3.00	3.20	3.40
A2	4.50	5.00	5.50
b	0.55	0.60	0.80
c	0.45	0.50	0.70
D	43.50	44.00	44.50
D1	40.50	41.00	41.50
E	20.40	20.90	21.40
E1	12.75	13.25	13.75
e	1.27 BSC		
F	3.10	3.60	4.10
L	6.30	6.80	7.30
L1	3.23	3.73	4.23
M	33.9 REF		
M1	17.4 REF		


GENERIC MARKING DIAGRAM*


XXXX = Specific Device Code
 ZZZ = Assembly Lot Code
 AT = Assembly & Test Location
 Y = Year
 WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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